









(2,00 mm) .0787"
STMM, ZSTMM SERIES

SHROUDED IDC HEADER & STACKER

Mates with: TCSD

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?STMM or www.samtec.com?ZSTMM

Insulator Material: High Temperature

Terminal Material: Phosphor Bronze

Plating: Sn or Au over 50µ" (1,27 µm) Ni Current Rating: 3A per contact @ 80°C ambient

@ 80°C ambient
Operating Temp Range:
-55°C to +105°C with Tin;
-55°C to +125°C with Gold
RoHS Compliant:

Processing: Lead-Free Solderable:

Yes SMT Lead Coplanarity: (0,10 mm) .004" max

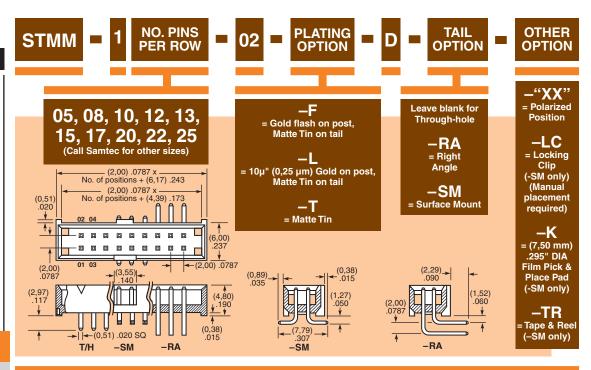
ALSO AVAILABLE

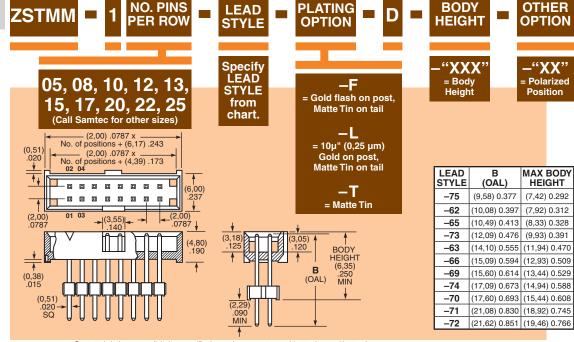
Shrouded board-to-board headers and stackers to mate with SQT, SQW, ESQW and SMM Series. See LTMM and ZLTMM Series.

Note: For added mechanical stability, Samtec recommends mechanical board spacers be used in applications with gold or selective gold plated connectors. Contact ipg@samtec.com for more information.

Note: Other Gold plating options available. Contact Samtec.

Note: This Series is non-standard, non-returnable.





Due to technical progress, all designs, specifications and components are subject to change without notice.

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